

# XBT-3535-UV-Mini

# Surface Mount 308 nm UVB LED



### **Features**

- UVB LED with peak wavelength from 300 315 nm
- Compact form factor: 3.5 mm x 3.5 mm package with optically transparent window
- Viewing angle of 130 degrees
- Standard SMT process





### **Applications**

- Phototherapy
- Disinfection
- UV curing
- Fluorescence spectroscopy
- Analytical instruments

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# **Ordering Information**

### Ordering Part Numbers<sup>1</sup>

Wavelength Range	Wavelength Bins	Radiome	etric Flux	Ordering Part Number	
(nm)	Wavelength bills	Bin Kit Flux Code Min. Flux (mW)		Ordering Fart Number	
300 - 315	300, 305, 310	СВ	25	XBT-3535-UV-A130H-M-CB-300-00	

#### **Part Number Nomenclature**

XBT 3535 UV A130H-M <FFWWW-#>

Product Family	Package Size	Color	Package Configuration	Bin Kit
XBT: UVC Surface Mount Package	3535: 3.5 mm x 3.5 mm	UV: Ultraviolet	A130H-M: 130 deg viewing angle, Mini	Flux and Wavelength bin kit code - See ordering information

<sup>1.</sup> Flux Bin listed is minimum bin shipped, higher bins may be included at Luminus' discretion.

# **Binning Structure**

XBT-3535-Mini LEDs are tested at a drive current of 150 mA, 20 ms single pulse at 25°C and placed into one of the following radiometric flux and wavelength bins. The LEDs can also be driven at different drive currents to achieve the correlated flux values listed in the table.

#### Radiometric Flux Bins<sup>1,2</sup>

Color	Floor Dim3	Binning @ 150 mA, T <sub>c</sub> = 25°C <sup>4,5</sup>		Correlated Minimum Flux (mW) @ T <sub>c</sub> = 25°C		
Color	Flux Bin <sup>3</sup>	Min. Flux (mW)	Max. Flux (mW)	50 mA	100 mA	225 mA
UV	СВ	25	30	8.3	16.7	37.5
	CC	30	35	10.0	20.0	45.0
	CD	35	40	11.7	23.3	52.5
	CE	40	45	13.3	26.7	60.0
	CF	45	50	15.0	30.0	67.5

#### Wavelength Bins<sup>2</sup>

Color	Wayalangth Bin36	Binning @ 150	mA, T <sub>c</sub> = 25°C <sup>4,5</sup>
Color	Wavelength Bin <sup>3,6</sup>	Minimum Wavelength (nm)	Maximum Wavelength (nm)
	300	300	305
UV	305	305	310
	310	310	315

#### **Forward Voltage Bins**

Color	Voltago Pin	Binning @ 150	) mA, T <sub>c</sub> = 25°C
COIOI	Voltage Bin	Minimum Voltage (V)	Maximum Voltage (V)
UV	V3	5.0	5.5
	V4	5.5	6.0
	V5	6.0	6.5
	V6	6.5	7.0

- 1. Luminus maintains a +/- 6% tolerance on flux measurements.
- 2. Products are production tested then sorted and packed by bin.
- 3. Individual bins are not orderable. Please refer to the Product Ordering information page for a list of orderable bin kits.
- 4. Product test condition: 150 mA, 20 ms pulse at 25 °C.
- 5.  $T_c$  = Case temperature.
- 6. The wavelength bin as marked on the product label may be followed by a letter which is for internal use only.

# Absolute Maximum Ratings<sup>1</sup>

Parameter	Symbol	Value	Unit	
Forward Current	l <sub>f max</sub>	225	mA	
Ctarage Temperature	T <sub>s min</sub>	-40	°C	
Storage Temperature	T <sub>s max</sub>	100		
Junction Temperature	T <sub>j max</sub>	85	°C	
ESD sensitivity ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V <sub>ESD</sub>	8000	V	

<sup>1.</sup> XBT-3535-Mini LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime is a function of drive current and junction temperature. Contact Luminus for more information on lifetimes.

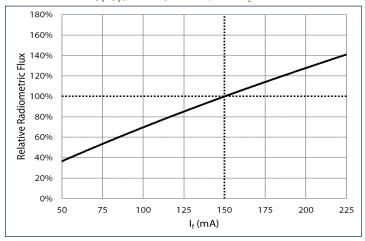
### Device Performance<sup>1,2</sup>

Optical and Electrical Characteristics	Symbol	Value	Unit
Test Current	I <sub>f</sub>	150	mA
	V <sub>f min</sub>	5.0	
Forward Voltage	$V_{ftyp}$	5.6	V
	$V_{fmax}$	7.0	
FWHM	Δλ	10	nm
Viewing Angle	2θ <sub>1/2</sub>	130	0
Thermal Characteristics			
Electrical Thermal Resistance (junction to case) <sup>3</sup>	R <sub>θj-c (elec.)</sub>	12.2	°C/W

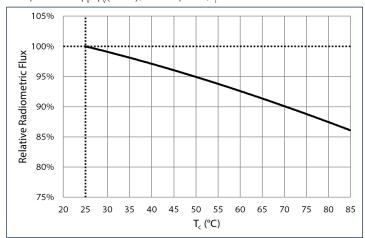
- 1. Ratings are based on operation at a constant temperature of  $T_c$  = 25°C. Test conditions: 150 mA, 20 ms pulse at 25°C.
- 2. XBT-3535-Mini LEDs are short wavelength, deep UV LEDs. During operation, the LED emits high intensity UVB radiation, which is harmful to skin and eyes. UV light is also hazardous to skin and may cause cancer. Avoid exposure to deep UV light when LED is operational.
- 3. Measurements are in accordance with JEDEC 51-14.

#### Relative Radiometric Flux

Forward current:  $\phi_v/\phi_v(150 \text{ mA})$ , 20 ms pulse,  $T_c = 25^{\circ}\text{C}$ 

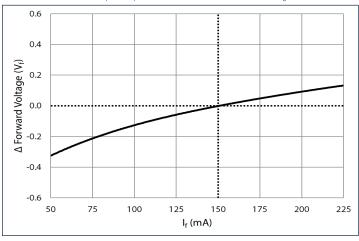


Temperature:  $\varphi_{r}/\varphi_{r}(25^{\circ}\text{C})$ , 20 ms pulse,  $I_{r} = 150 \text{ mA}$ 

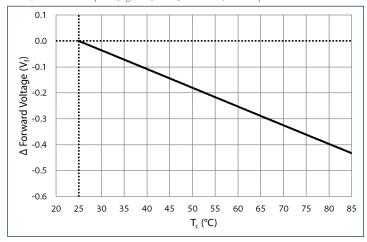


#### **Forward Voltage Shift**

Forward current:  $\Delta V_f = V(I_f) - V(150 \text{ mA})$ , 20 ms pulse,  $T_c = 25^{\circ}\text{C}$ 

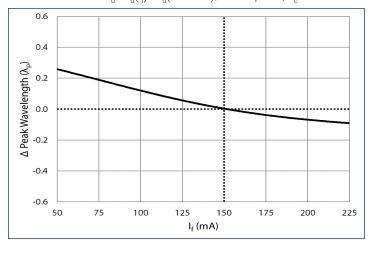


Temperature:  $\Delta V_f = V(T_c) - V(25^{\circ}C)$ , 20 ms pulse,  $I_f = 150$  mA

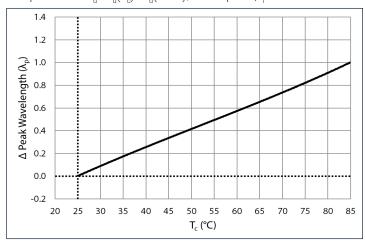


#### **Peak Wavelength Shift**

Forward current:  $\Delta \lambda_d = \lambda_d(I_f) - \lambda_d(150 \text{ mA})$ , 20 ms pulse,  $T_c = 25^{\circ}\text{C}$ 



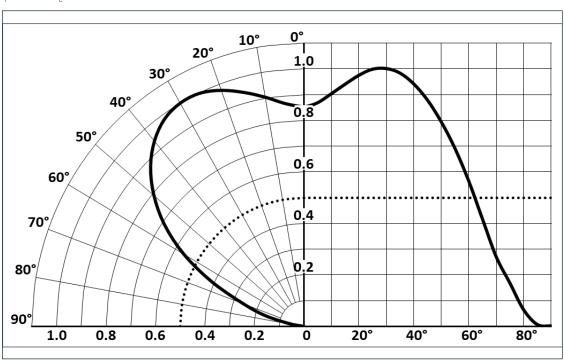
Temperature:  $\Delta \lambda_d = \lambda_d(T_c) - \lambda_d(25^{\circ}C)$ , 20 ms pulse,  $I_f = 150$  mA



# **Angular distribution and Typical Spectrum**

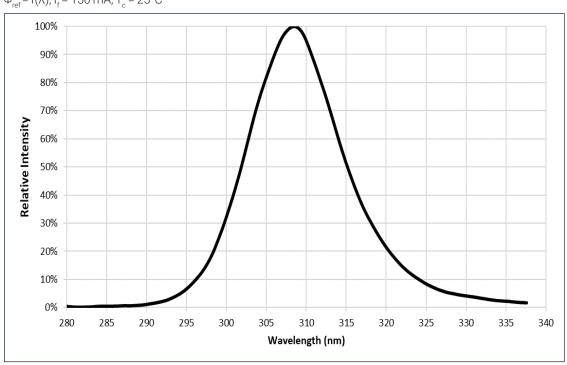
### **Angular distribution**

 $I_f = 150 \text{ A}; T_c = 25^{\circ}\text{C}$ 

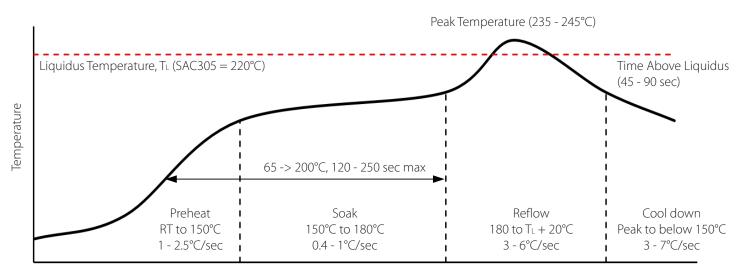


#### **Typical Spectrum**

 $\Phi_{ref} = f(\lambda); I_f = 150 \text{ mA}; T_c = 25^{\circ}\text{C}$ 



### **Soldering Profile**

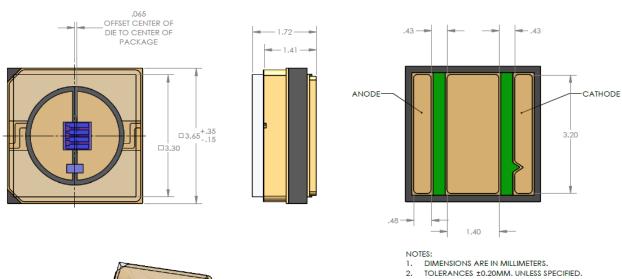


Time

SMT Rework Guideline	Manual Hotplate Reflow	Hot Air Gun Reflow
Heating Time	< 60 sec	
Hotplate Temperature	< 245°C < 150°C	

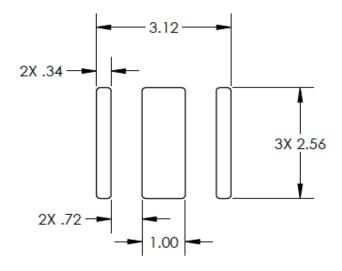
- 1. Product complies to Moisture Sensitivity Level 3 (MSL 3).
- 2. The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
- 3. During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N).
- 4. Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
- 5. Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB
- $6. \ Luminus\ recommends\ to\ use\ the\ solder\ paste\ data\ sheet\ information\ as\ a\ starting\ point\ in\ time\ temperature\ process\ development.$
- 7. These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. For more information, please refer to:
  - $\underline{https://luminus devices.zendesk.com/hc/en-us/articles/360060306692-How-do-l-Reflow-Solder-Luminus-SMD-Components-to-learned and the substitution of the substituti$
- 8. For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.

### **Mechanical Dimensions**





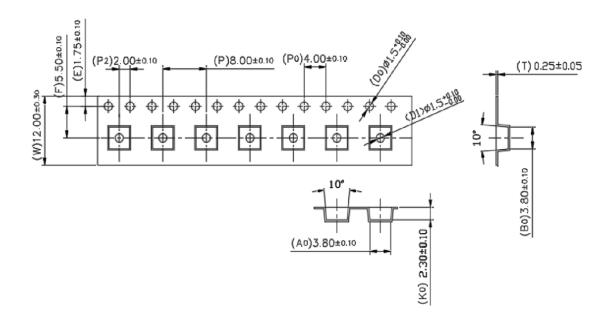
## Recommended Solder Pad

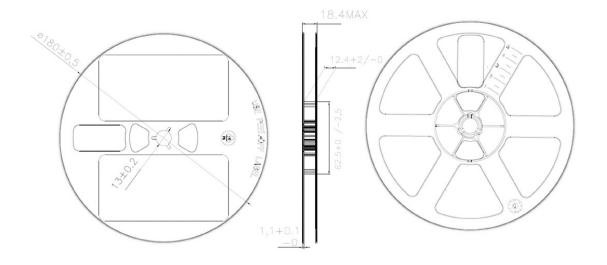


# **Shipping Reel Outline**

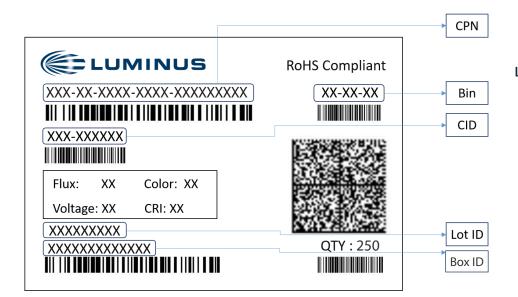
 $All\,XBT-3535\,products\,are\,packaged\,and\,labeled\,with\,their\,respective\,bin\,as\,outlined\,in\,the\,tables\,on\,page\,3.$ 

Each reel will only contain one flux and one wavelength bin.





## **Shipping Label**



#### **Label Fields:**

- CPN: Luminus ordering part number
- CID: Customer's part number
- QTY: Quantity of devices in pack
- Flux: Bin as defined on page 3
- Wavelength: Bin as defined in page 3
- Voltage: Bin as defined on page 3
- Color: Bin as defined on page 3
- CRI: NA

#### **Packing Configuration:**

- Maximum of 250 devices per reel, minimum of 50 devices per reel
- Partial reels may be shipped
- · Each reel is enclosed in anti-static bag
- Shipping label is placed on top of each pack

### **Notes**

#### **Static Electricity**

This product is sensitive to static electricity, and care should be taken when handling them. Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken to isolate LED processing equipment from potential sources of voltage surges.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

#### **Eye Safety**

According to the test specification risk group IEC 62471: 2008-Non-GLS under 150 mA, this product complies to Risk group 3 (RG3) High risk, exceed the limits for Risk Group 2.

Warning: This product emits invisible light - there is no aversion response.

Avoid eye and skin exposure to un-shielded product.

For more information, please refer to: <a href="https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397">https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397</a>

# **Revision History**

Rev	Date	Description of Change
01	06/25/2023	Initial release